

Crystal Clear Technology

Product Specification

T1010T05X00XX

(REVISION 4)

Customers are requested to read through and understand this product specification. If no feedback is received from customer by 30 days, it is deemed that customer has fully need, understand and agreed on the specification set forth in this document.

Acknowledged by,

Date: _____

(CUSTOMER'S SIGNATURE)

REMARK: AFTER THE ACKNOWLEDGEMENT HAS BEEN SIGNED, PLEASE RETURN TO CCT.

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**2. Record of Revision**

Rev	Date	Item	Page	Comment	Prepared	Checked
REV1	21/09/18			Initial Release	Othman	WHong
REV2	24/09/18	3	4	Revise Outline Dimensions		
		4.2	6	Add Touch Panel on Note (1)		
		5.3	11	Remove AVDD, VGH, VGL		
		5.4	12	Change IRQ to INT	Othman	WHong
REV3	17/02/20	4.3	7	Add I2C timing chart		
		7	16	Revise Note (2), add Note (3)		
		10	24	Revise optical characteristic		
		11	27	Revise Precaution	Othman	WHong
REV4	02/09/20	1	2	Update Drawing	Fathiyah	WHong
				Changed title to (CTP - I2C)		
				Added AC/DC Characteristics (CTP - USB)		
		3	4	Changed CTP to CTP(I2C)		
				Added CTP (USB) specification		
				Revised Note		
		3	6	Revised Standard TFT Module Table		
		4	7	Changed VSS to GND		
		4.3	8	Added Min & Max Luminous Intensity		
		5	12	Changed title to AC/DC Characteristics (CTP – I2C)		
				Changed VSS to GND		
		6	14	Added AC/DC Characteristics (CTP – USB)		
		7	16	Changed VSS to GND		
		8	19	Added Min & Max Brightness		
				Added Color Chromaticity		
		11	28	Revised Precaution of Operation		
		12	35&36	Added Mechanical Drawing		



3. General Specification

T1010T05X00XX is 10.1" colour TFT-LCD (Thin Film Transistor Liquid Crystal Display) module composed of LCD panel, driver ICs control circuit, LED backlight, Capacitive Touch Panel and HDMI converter. By applying 1024x600 images are displayed on the 10.1" diagonal screen. Display 262K colours by R.G.B signal input.

General Specification are summarized in the following table:

	Item	Specifications	Unit	Note
	Size (Diagonal)	10.1	inch	
	Outline dimensions	235.0(W) x 143.0(H) x 4.50(T)	mm	(1)
TFT	Display type	262K color TFT, Normally White	-	(2)
	Viewing direction	12	O'clock	
	TFT Active area	222.72(W) x 125.28(H)	mm	
	TFT Resolution	1024(RGB) x 600	-	
	Pixel size	0.2175(W) x 0.2088(H)	mm	
	Pixel arrangement	RGB vertical strip	-	
	TFT Interface mode	LVDS	-	
	Luminance	250 (Typ.)	cd/m ²	(3)
	CTP (I2C)	CTP Active area	222.72(W) x 125.28(H)	mm
CTP Resolution		1024 x 600	-	
CTP Origin		Top-left (FPC down)	-	
CTP Controller		FT5426	-	
CTP Interface mode		I2C	-	
Touch mode		10 fingers multi touch	-	
Cover lens material		Glass	-	
Transmittance		85(min)	%	
CTP (USB)	CTP Active area	223.22(W) x 125.78(H)	mm	
	CTP Resolution	16384 x 16384	-	
	CTP Origin	Top-left (FPC down)	-	
	CTP Controller	ILI2511	-	
	CTP Interface mode	USB	-	
	Touch mode	10 fingers multi touch	-	
	Cover lens material	Glass	-	
	Transmittance	85	%	



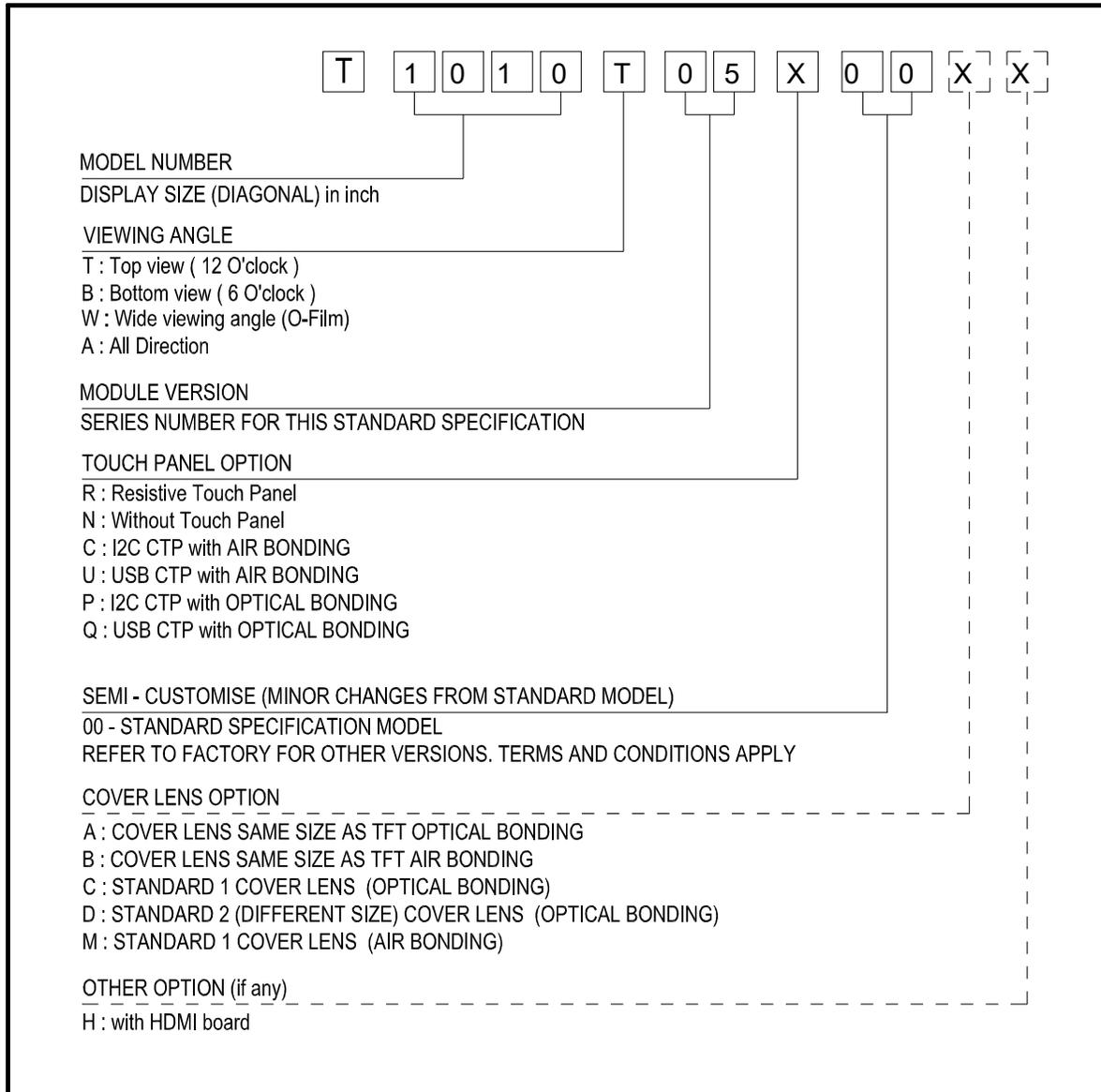
HDMI	Board dimensions	85.0(W) x 54.0(H) x 8.38(T)	mm	
	HDMI Driving IC	TFP401APZP + SN75LVDS83BDGG	-	
	Display Resolution	1024 x 600	-	
	Display Clock	60.0	Hz	
	Operating temperature	-20.0 ~ +70.0	°C	(4)
	Storage temperature	-30.0 ~ +80.0	°C	(4)

Note:

- (1) FPC or Wire or Foam Tape or PCBA are not included.
- (2) Color tone is slightly changed by temperature and driving voltage.
- (3) Brightness on LCD surface. Module with CTP or RTP, brightness will be about 20% (max) lower on the touch panel surface.
- (4) This product specification shows range of value either in the minimum, typical or maximum category. Operating under extreme condition, bordering on the minimum or maximum range, does not mean that the product can survive perpetually under these extremities. In fact, it only means that the product can operate under such condition with no information of lifetime, other than those already indicated in the specification. User is advised to test it on their own if the specification's reliability data did not indicate it.



STANDARD TFT MODULE ORDER INFORMATION (TABLE)



4. AC/DC Characteristics (TFT)

4.1 Absolute Maximum Ratings (GND = 0V, Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Note
Power Supply Voltage	V _{DD}	-0.3	-	5.0	V	
Backlight Forward Current	I _f	-	-	390	mA	
Storage Humidity	H _{ST}	10	-	90	%RH	(1)
Storage Temperature	T _{ST}	-30	-	+80	°C	
Operating Humidity	H _{OP}	10	-	90	%RH	(1)
Operating Temperature	T _{OP}	-20	-	+70	°C	

Note:

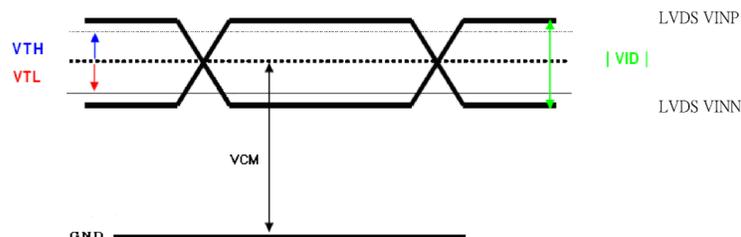
- (1) At 25±5°C. Absolute humidity shall be less than 90%RH at +60°C.
- (2) Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only. Functional operation of this device at these or any other conditions above those indicated in the operational sections of this specification is not implied and exposure to absolute maximum rating conditions for extended periods may affect device reliability.

4.2 Electrical Characteristics (GND = 0V, V_{DD} = 3.3V, Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Note
Power Supply Voltage	V _{DD}	3.0	3.3	3.6	V	(2)
Operation Current	I _{DD}	120	155	190	mA	
Logic Input Voltage (LVDS:IN+, In-)	V _{CM}	$\frac{V_{ID}}{2}$	-	$\frac{2.4 - V_{ID}}{2}$	V	(3)
	V _{ID}	200	-	600	mV	(3)
	V _{TH}	-	-	100	mV	V _{CM} = 1.2V (3)
	V _{TL}	-100	-	-	mV	

Note:

- (1) The recommended operating conditions refer to a range in which operation of this product is guaranteed. Accordingly, please make sure that the module is used within this range. And these current values are measured under the condition that all devices are stopped, each component is stable and logic signal is input.
- (2) The supply voltage is measured and specified at the interface connector of LCM.
- (3) LVDS Signal.



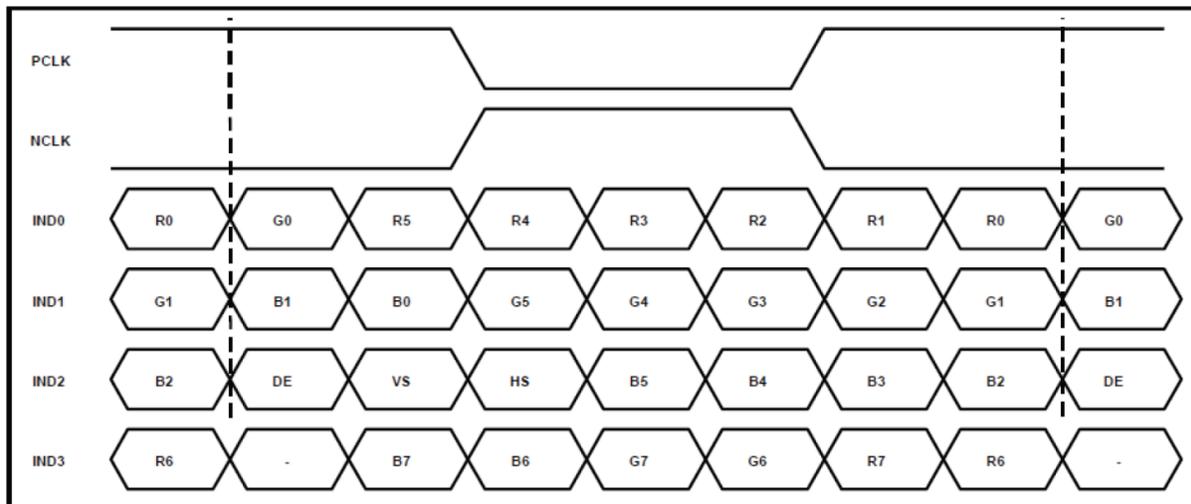
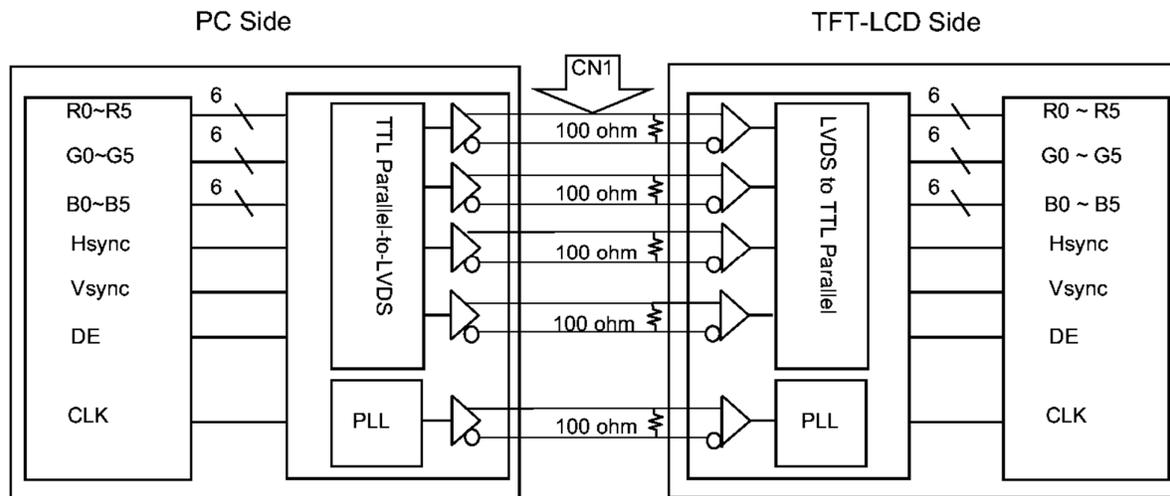
4.3 LED Backlight Specification (Ta = 25°C)

Item	Symbol	Condition	Min	Typ	Max	Unit
LED Supply Voltage	VLED	If = 260mA	7.7	8.5	9.4	V
LED Supply Current	If		-	260	-	mA
Luminous Intensity	LV	White	200	250	350	cd/m ²
Half Life Expectancy	LL	If = 260mA	20000	-	-	hrs
LED Configuration	39 White LED, 3 in Series, 13 in Parallel					

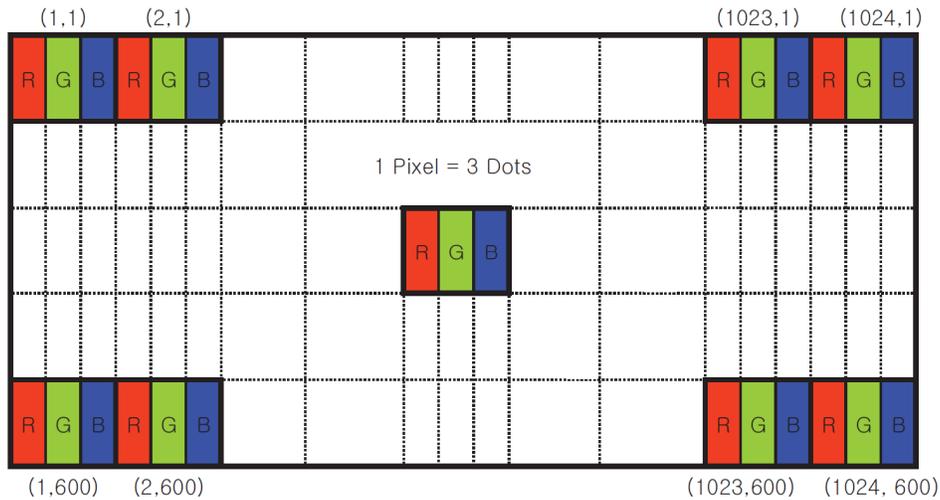
Note:

- (1) The LED Supply Voltage is defined by the number of LED at Ta = 25°C and If = 260mA.
- (2) The “Half Life Expectancy” is defined as the module brightness decrease to 50% of original brightness at Ta = 25°C and If = 260mA /LED. The LED lifetime can decrease if the operating If is higher than 260mA /LED.
- (3) Brightness measurement done at TFT surface.

4.4 LVDS Interface



4.5 Data Input Format

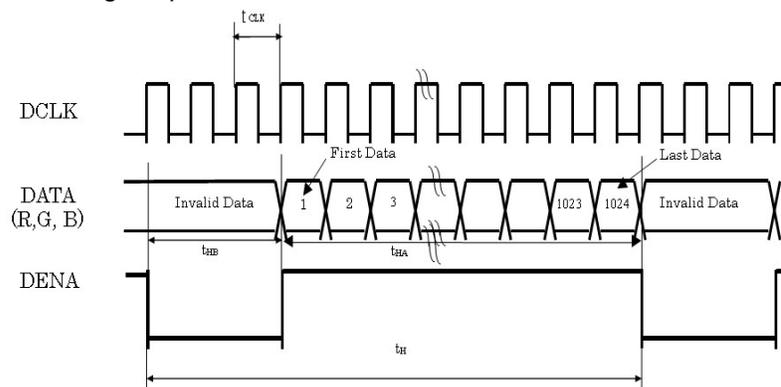


4.6 Signal Timing Specification

The operation by DE signal only.

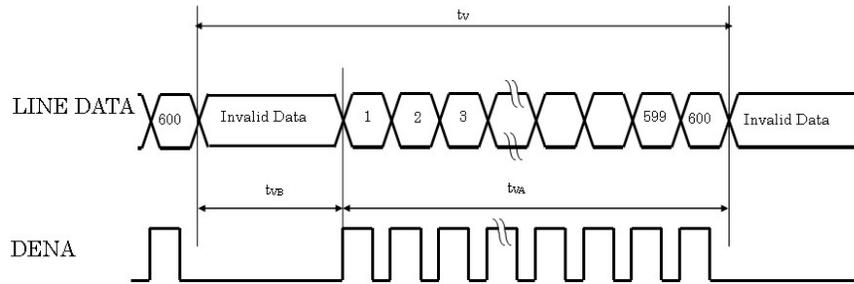
Item		Symbols	Min	Typ	Max	Unit
Clock	Frequency	tCLK	45	51.2	57	MHz
Data Enable	Horizontal Total Time	tH	1324	1344	1364	tCLK
	Horizontal Effective Time	tHA	1024			tCLK
	Horizontal Blank Time	tHB	300	320	340	tCLK
	Vertical Total Time	tV	625	635	645	tH
	Vertical Effective Time	tVA	600			tH
	Vertical Blank Time	tVB	25	35	45	tH

4.6.1 Horizontal Timing Sequence

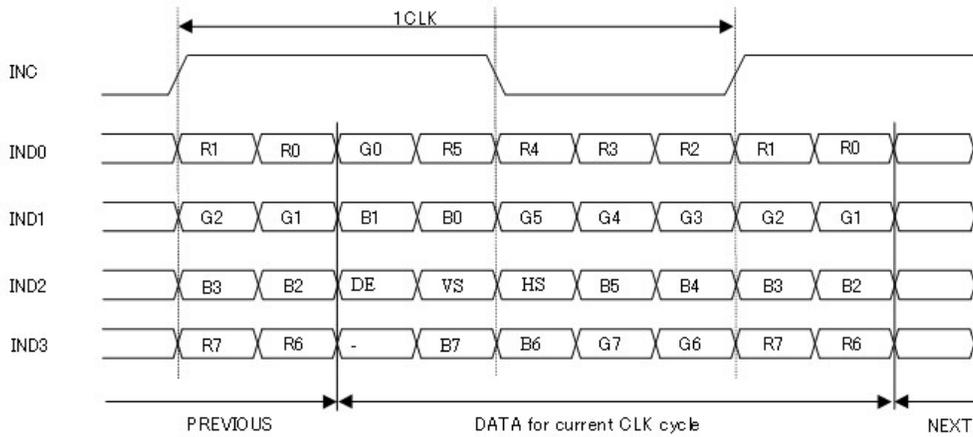




4.6.2 Vertical Timing Sequence



4.6.3 LVDS Input Data Mapping





4.7 Pin Assignment Table

4.7.1 CN2 – Input Signal

Pin No.	Symbol	I/O	Description	Note
1	NC	-	No Connection	
2 - 3	VDD	P	Power Supply	
4 - 7	NC	-	No Connection	
8	RIN0-	I	LVDS Negative data signal (-)	
9	RIN0+	I	LVDS Positive data signal (+)	
10	GND	P	Ground	
11	RIN1-	I	LVDS Negative data signal (-)	
12	RIN1+	I	LVDS Positive data signal (+)	
13	GND	P	Ground	
14	RIN2-	I	LVDS Negative data signal (-)	
15	RIN2+	I	LVDS Positive data signal (+)	
16	GND	P	Ground	
17	LVDS_CLK-	I	LVDS Negative CLK signal (-)	
18	LVDS_CLK+	I	LVDS Positive CLK signal (+)	
19	GND	P	Ground	
20	RIN3-	I	LVDS Negative data signal (-)	
21	RIN3+	I	LVDS Positive data signal (+)	
22	GND	P	Ground	
23 - 40	NC	-	No Connection	

4.7.2 LED Backlight

Pin No.	Symbol	I/O	Description	Note
1	A	P	Anode	
2	K	P	Cathode	

5. AC/DC Characteristics (CTP – I2C)

5.1 Absolute Maximum Ratings (GND = 0V, Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Note
Power Supply Voltage	VDD	-0.3	-	5.0	V	
Storage Humidity	HST	10	-	90	%RH	(1)
Storage Temperature	TST	-30	-	+80	°C	
Operating Humidity	HOP	10	-	90	%RH	(1)
Operating Temperature	TOP	-20	-	+70	°C	

Note:

- (1) At 25±5°C. Absolute humidity shall be less than 90%RH at +60°C.
- (2) Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only. Functional operation of this device at these or any other conditions above those indicated in the operational sections of this specification is not implied and exposure to absolute maximum rating conditions for extended periods may affect device reliability.

5.2 Electrical Characteristics (GND = 0V, VDD = 3.3V, Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Note
Power Supply Voltage	VDD	2.8	3.3	3.5	V	
Operation Current Free Mode	IDD	-	16.5	35	mA	VDD = 3.3V
Operation Current Watch Mode		-	16.5	35	mA	
Operation Current Active Mode		-	18.5	40	mA	
Operation Current Fast Mode		-	18.5	40	mA	

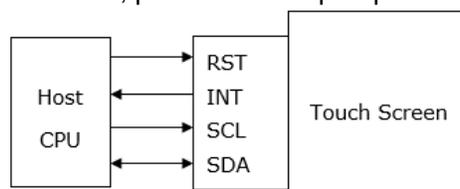
Note:

- (1) The recommended operating conditions refer to a range in which operation of this product is guaranteed. Accordingly, please make sure that the module is used within this range. And these current values are measured under the condition that all devices are stopped, each component is stable and logic signal is input.

5.3 I2C Interface

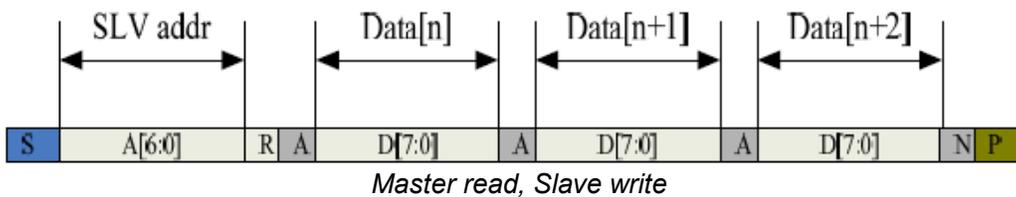
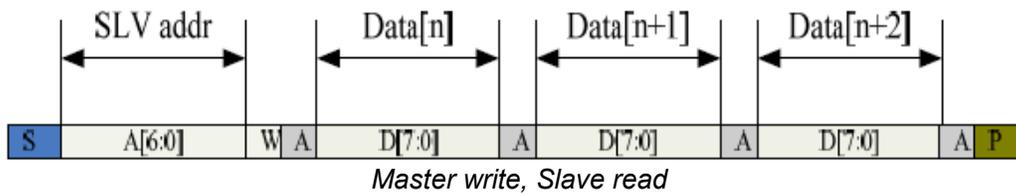
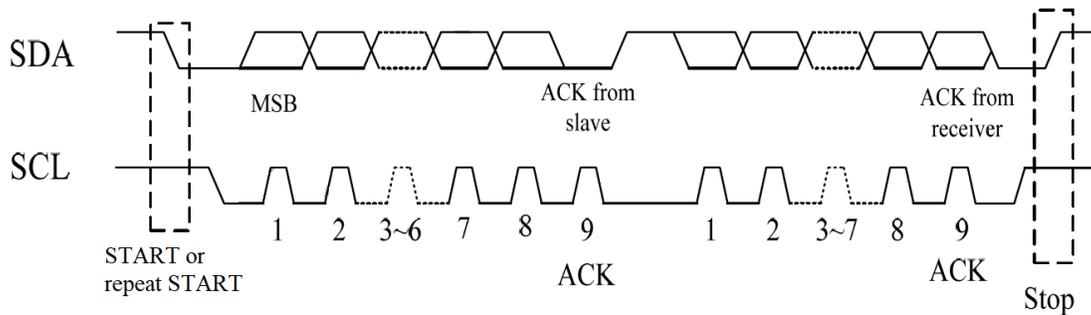
Touch panel is used as I2C Slave Device, I2C Slave address is 0x70.

The system block diagram is as shown in below. There are three communication pins connected between CPU and Touch Panel Module which are including external interrupt INT, I2C pins SCL and SDA. The INT is active low while the touch state is calculated by Touch Panel Module and the touch information can be translated via I2C communication interface. The I2C data format, protocol and report packet are described as following.



5.4 I2C Timing Characteristics

Parameter	Min	Typ	Max	Unit
SCL frequency	0	-	400	KHz
Bus free time between a STOP and START condition	1.3	-	-	us
Hold time (repeated) START condition	0.6	-	-	us
Data setup time	100	-	-	us
Setup time for a repeated START condition	0.6	-	-	us
Setup time for STOP condition	0.6	-	-	us



5.5 Pin Assignment Table

Pin No.	Symbol	I/O	Description	Note
1	V _{DD}	P	Supply Voltage	
2 - 3	GND	P	Ground	
4	SCL	I	I2C Clock signal	
5	SDA	I/O	I2C Data signal	
6	GND	P	Ground	
7	INT	O	Interrupt signal	
8	RST	I	Reset signal	



6. AC/DC Characteristics (CTP – USB)

6.1 Absolute Maximum Ratings (GND = 0V, Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Note
Power Supply Voltage	VDD	-0.3	-	6.0	V	
Storage Humidity	HST	10	-	90	%RH	(1)
Storage Temperature	TST	-30	-	+80	°C	
Operating Humidity	HOP	10	-	90	%RH	(1)
Operating Temperature	TOP	-20	-	+70	°C	

Note:

- (3) At 25±5°C. Absolute humidity shall be less than 90%RH at +60°C.
 (4) Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only. Functional operation of this device at these or any other conditions above those indicated in the operational sections of this specification is not implied and exposure to absolute maximum rating conditions for extended periods may affect device reliability.

6.2 Electrical Characteristics (GND = 0V, VDD = 5.0V, Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Note
Power Supply Voltage	VDD	4.4	5.0	5.5	V	
Operation Current	IDD	-	75	-	mA	
Input Low	VIL	-	-	0.8	V	
Input High (Driven)	VIH	2.0	-	-	V	
Differential Input Sensitivity	VDI	0.2	-	-	V	(D+) – (D-)
Differential Common-Mode Range	VCM	0.8	-	2.5	V	Include VDI Range
Single-Ended Receiver Threshold	VSE	0.8	-	2.0	V	
Receiver Hysteresis	VRH	-	200	-	mV	
Output Low (Driven)	VOL	0	-	0.3	V	
Output High (Driven)	VOH	2.8	-	3.6	V	
Output Signal Cross Voltage	VCRS	1.3	-	2.0	V	
Pull-Up Resistor	RPU	1.425	-	1.575	kΩ	
Pull-Down Resistor	RPD	14.25	-	15.75	kΩ	
Termination Voltage for Upstream Port Pull Up (RPU)	VTRM	3.0	-	3.6	V	

Note:

- (2) The recommended operating conditions refer to a range in which operation of this product is guaranteed. Accordingly, please make sure that the module is used within this range. And these current values are measured under the condition that all devices are stopped, each component is stable and logic signal is input.



6.3 Pin Assignment Table

Pin No.	Symbol	I/O	Description	Note
1	GND_EARTH	P	Ground	
2	VDD	P	5V USB Power Supply	
3	GND	P	Ground	
4	D+	I/O	USB Data+	
5	D-	I/O	USB Data-	



7. AC/DC Characteristics (HDMI)

7.1 Absolute Maximum Ratings (GND = 0V, Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Note	
Power Supply Voltage	VDD	-0.3	-	+6.0	V		
Storage Humidity	HST	10	-	90	%RH	(1)	
Storage Temperature	TST	-30	-	+80	°C		
Operating Humidity	HOP	10	-	90	%RH	(1)	
Operating Temperature	TOP	-20	-	+70	°C		

Note:

- (1) At 25±5°C. Absolute humidity shall be less than 90%RH at +60°C.
- (2) Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only. Functional operation of this device at these or any other conditions above those indicated in the operational sections of this specification is not implied and exposure to absolute maximum rating conditions for extended periods may affect device reliability.

7.2 Electrical Characteristics (GND = 0V, VDD = 5.0V, Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Note	
Power Supply Voltage	VDD	4.85	5.0	5.5	V		
Operation Current	IDD(BOARD)	-	110	120	mA		
	IDD(TOTAL)	-	1.2	1.32	A	(2)	
Analog input differential voltage	VID	75	-	1200	mV		
Analog input common voltage	VIC	AVDD-300	-	AVDD-37	mV		
Open-circuit analog input voltage	VI(OC)	AVDD-10	-	AVDD+10	mV		
PWM Control Level	PWM High Level	VPWMH	1.2	-	5.5	V	
	PWM Low Level	VPWML	0	-	0.4	V	
PWM Control Frequency	FPWM	5	-	100	KHz		

Note:

- (1) The recommended operating conditions refer to a range in which operation of this product is guaranteed. Accordingly, please make sure that the module is used within this range. And these current values are measured under the condition that all devices are stopped, each component is stable and logic signal is input.
- (2) The total consumption of HDMI board + TFT module (with backlight).



7.3 Pin Assignment Table

7.3.1 PWM Pin Assignment (CN61)

Pin No.	Symbol	I/O	Description	Note
1	NC	-	No Connection	
2	PWM	I	Brightness control	(1)
3	GND	P	Ground	

Note:

(1) PWM signal is used to control the backlight of TFT. Refer section 6.2 for the specification.

7.3.2 HDMI Pin Assignment (J11)

Pin No.	Symbol	I/O	Description	Note
1	D2+	I	TMDS Data2+	
2	D2_S	-	TMDS Data2 Shield	
3	D2-	I	TMDS Data2-	
4	D1+	I	TMDS Data1+	
5	D1_S	-	TMDS Data1 Shield	
6	D1-	I	TMDS Data1-	
7	D0+	I	TMDS Data0+	
8	D0_S	-	TMDS Data0 Shield	
9	D0-	I	TMDS Data0-	
10	CLK+	I	TMDS Clock+	
11	CLK_S	-	TMDS Clock Shield	
12	CLK-	I	TMDS Clock-	
13	CEC	-	No Connection	
14	NC	-	No Connection	
15	SCL	I	DDC Clock	
16	SDA	I/O	DDC Data	
17	DDC	-	DDC/CEC Ground	
18	+5V	P	Power EDID/DDC	
19	DET	-	Hot Plug Detect	



7.3.3 USB Pin Assignment (J51)

Pin No.	Symbol	I/O	Description	Note
1	VUSB	P	+5V DC	
2	D-	I/O	Data-	
3	D+	I/O	Data+	
4	ID	-	No Connection	
5	GND	P	Ground	

8. Optical Characteristics

Item	Symbol	Condition	Min	Typ	Max	Unit	Note
Brightness	Bp	$\theta=0^\circ$	200	250	350	cd/m ²	(2)
Uniformity	ΔBp	$\Phi=0^\circ$	75	-	-	%	(2)(3)
Viewing Angle	3:00	$Cr \geq 10$	-	80	-	degree	(4)
	6:00		-	70	-		
	9:00		-	80	-		
	12:00		-	60	-		
Contrast Ratio	Cr	$\theta=0^\circ$ $\Phi=0^\circ$ $Ta=25^\circ C.$	500	600	-	-	(5)
Response Time	Tr / Tf		-	25	40	ms	(6)
Colour Chromaticity	Wx		0.25	0.28	0.31	-	(7)
	Wy		0.27	0.30	0.33	-	
NTSC Ratio	S		-	50	-	%	(7)
CTP Transmittance	T		85	90	-	%	(8)

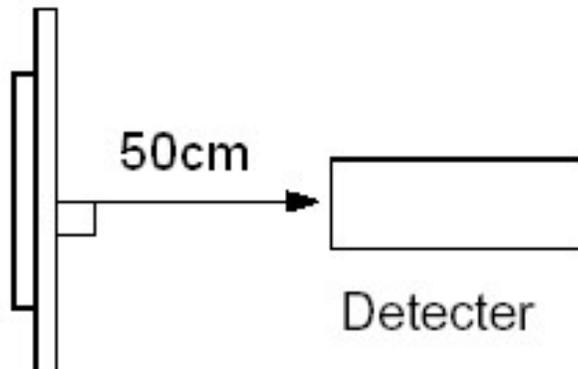
Note:

- (1) The parameter is slightly changed by temperature, driving voltage and materiel.
- (2) The data are measured after LEDs are turned on for 5 minutes. LCM displays full white. The brightness is the average value of 9 measured spots. Measurement equipment BM-7A.

Measuring condition:

- Measuring surroundings: Dark room.
- Measuring temperature: $Ta=25^\circ C.$
- Adjust operating voltage to get optimum contrast at the center of the display.

Measured value at the center point of LCD panel after more than 5 minutes while backlight turning on.

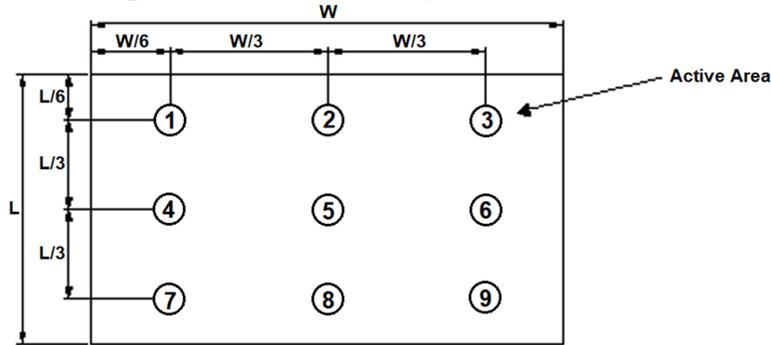


(3) The luminance uniformity is calculated by using following formula:

$$\Delta Bp = Bp (\text{Min.}) / Bp (\text{Max.}) \times 100 (\%)$$

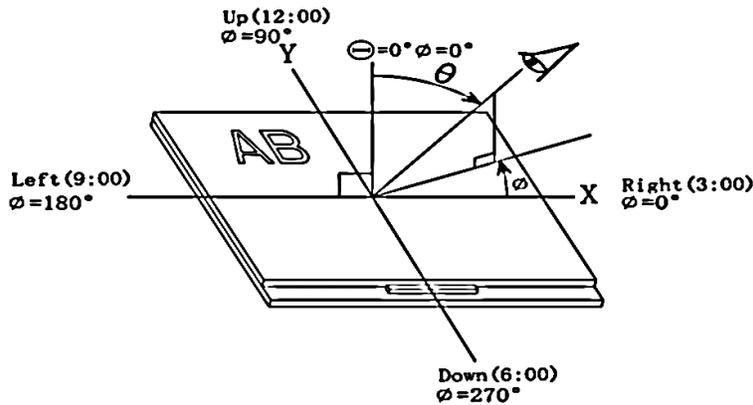
Bp (Max.) = Maximum brightness in 9 measured spots.

Bp (Min.) = Minimum brightness in 9 measured spots.

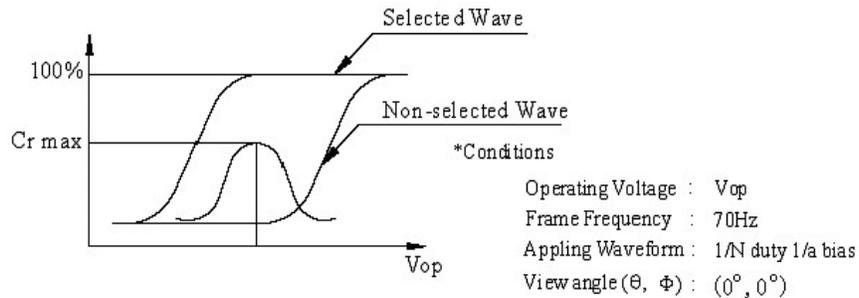


(4) The definition of viewing angle:

Refer to the graph below marked by θ and Φ



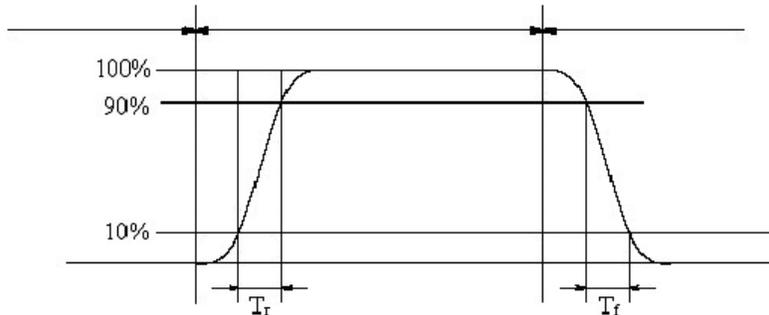
(5) Definition of contrast ratio.



$$\text{Contrast ratio (Cr)} = \frac{\text{Brightness of selected dots}}{\text{Brightness of non-selected dots}}$$

(6) Definition of Response time.

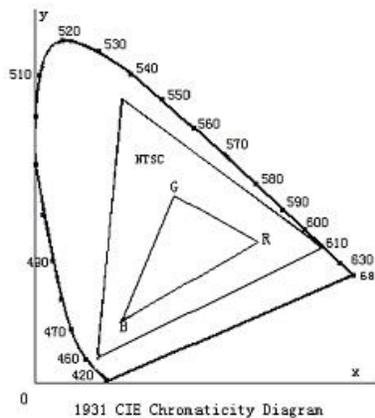
The output signals of photo detector are measured when the input signals are changed from “black” to “white” (falling time) and from “white” to “black” (rising time), respectively. The response time is defined as the time interval between the 10% and 90% of amplitudes. Refer to figure as below.



The Definition of response time

(7) Definition of Color of CIE Coordinate and NTSC Ratio.

Colour coordinates measured at centre point of LCD.



(8) Definition of The transmittance

Measurements shall be made at viewing angle of $\theta = 0^\circ$ and at the center of the touch panel by using BM-7A. Transmittance shall be calculated by the difference of the luminance between a standard light source with touch panel and a standard light source without touch panel.

$$\text{Transmittance} = \frac{\text{Luminance on touch panel surface}}{\text{Luminance of standard light source}}$$



9. Reliability Test Condition

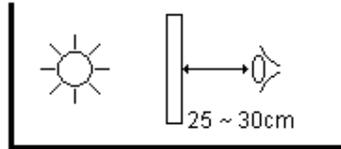
Item		Test Condition	Note
Operating	High Temperature	+70°C, 240hrs	(3)
	Low Temperature	-20°C, 240hrs	(3)
Storage	High Temperature	+80°C, 240hrs	(3)
	Low Temperature	-30°C, 240hrs	(3)
	High Temperature and High Humidity	+60°C, 90%RH, 240hrs	(3)
	Cycle	RT (0m) → -30°C (30m) → RT (5m) → +80°C (30m) → RT (5m) 50 cycles	(1)(2)(3)

Note:

- (1) RT means Room Temperature.
- (2) m means minute.
- (3) Before cosmetic and functional test, the product must have enough recovery time, at least 2 hours at room temperature.

10. Inspection Criteria

- Inspection distance: 25~30cm.
- From lamp source to product: 250 ± 100cm.
- Angle of inspection: Ambient brightness 1k-1.5k lux inspection from front view, perpendicular to the surface of product.

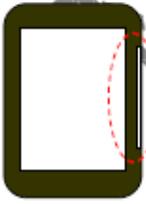
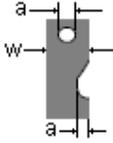


No	Defect	Definition of defect	Inspection Criteria															
1	a) Definition of dot	<p>The size of defective dot over 1/2 of whole is regards as one defective dot.</p> <p>Smaller than 1/2 Larger than 1/2</p> <p>'No dot defect' (ignore) '1 dot defect' (counted)</p>	<p>A - Viewing area B - Viewing area C - Outside Viewing area</p>															
	b) Bright Dot	Dot appear bright and unchanged in size when LCD panel is displaying black pattern.	<table border="1"> <thead> <tr> <th>Defect</th> <th>A</th> <th>B</th> <th>C</th> </tr> </thead> <tbody> <tr> <td>Bright Dot</td> <td>1</td> <td>1</td> <td rowspan="2">NC</td> </tr> <tr> <td>Dark Dot</td> <td>2</td> <td>2</td> </tr> <tr> <td>Total</td> <td colspan="2">4</td> <td></td> </tr> </tbody> </table> <p>NC – Not Count</p>	Defect	A	B	C	Bright Dot	1	1	NC	Dark Dot	2	2	Total	4		
	Defect	A		B	C													
	Bright Dot	1	1	NC														
Dark Dot	2	2																
Total	4																	
c) Dark Dot	Dot appear dark and unchanged in size when LCD panel is displaying pure color (RED, GREEN or BLUE) pattern.																	
d) 2 dot adjacent	<p>1 pair = 2 dots</p> <p>Type 1 Type 2</p> <p>or</p> <p>Type 3</p>	<table border="1"> <thead> <tr> <th>Defect</th> <th>Acc. Count</th> </tr> </thead> <tbody> <tr> <td>2 Bright dot Adjacent</td> <td>0</td> </tr> <tr> <td>2 Dark dot Adjacent</td> <td>1</td> </tr> </tbody> </table>	Defect	Acc. Count	2 Bright dot Adjacent	0	2 Dark dot Adjacent	1										
Defect	Acc. Count																	
2 Bright dot Adjacent	0																	
2 Dark dot Adjacent	1																	
2	<p>a) Black Spot b) White Spot c) Bright Spot d) Pin Hole e) Foreign Particle</p>	<p>- Black / Dark / Bright Spot is points on display which appear dark/bright and usually result from contamination. - These defect do not vary in size intensity (contrast) when contras is varied.</p>	<p>A - Viewing area B - Outside Viewing area</p>															



			<table border="1"> <thead> <tr> <th>Defect Category</th> <th>A</th> <th>B</th> </tr> </thead> <tbody> <tr> <td>D < 0.15</td> <td>NC</td> <td rowspan="4">NC</td> </tr> <tr> <td>0.15 ≤ D < 0.25</td> <td>2</td> </tr> <tr> <td>0.25 ≤ D ≤ 0.30</td> <td>1</td> </tr> <tr> <td>D > 0.30</td> <td>0</td> </tr> </tbody> </table>	Defect Category	A	B	D < 0.15	NC	NC	0.15 ≤ D < 0.25	2	0.25 ≤ D ≤ 0.30	1	D > 0.30	0
Defect Category	A	B													
D < 0.15	NC	NC													
0.15 ≤ D < 0.25	2														
0.25 ≤ D ≤ 0.30	1														
D > 0.30	0														
a) Black Line b) White Line c) Particle between POL and Glass d) Scratch on Glass		<table border="1"> <thead> <tr> <th>Defect Category</th> <th>A</th> <th>B</th> </tr> </thead> <tbody> <tr> <td>W < 0.03</td> <td>NC</td> <td rowspan="4">NC</td> </tr> <tr> <td>0.03 ≤ W ≤ 0.1</td> <td>2</td> </tr> <tr> <td>L ≤ 3.0</td> <td rowspan="2">0</td> </tr> <tr> <td>L > 3.0</td> </tr> </tbody> </table>	Defect Category	A	B	W < 0.03	NC	NC	0.03 ≤ W ≤ 0.1	2	L ≤ 3.0	0	L > 3.0		
Defect Category	A	B													
W < 0.03	NC	NC													
0.03 ≤ W ≤ 0.1	2														
L ≤ 3.0	0														
L > 3.0															
a) Air Bubble b) POL Bubble c) POL Dented		<table border="1"> <thead> <tr> <th>Defect Category</th> <th>A</th> <th>B</th> </tr> </thead> <tbody> <tr> <td>D < 0.20</td> <td>NC</td> <td rowspan="4">NC</td> </tr> <tr> <td>0.20 ≤ D < 0.30</td> <td>3</td> </tr> <tr> <td>0.30 ≤ D ≤ 0.50</td> <td>2</td> </tr> <tr> <td>D > 0.50</td> <td>0</td> </tr> </tbody> </table>	Defect Category	A	B	D < 0.20	NC	NC	0.20 ≤ D < 0.30	3	0.30 ≤ D ≤ 0.50	2	D > 0.50	0	
Defect Category	A	B													
D < 0.20	NC	NC													
0.20 ≤ D < 0.30	3														
0.30 ≤ D ≤ 0.50	2														
D > 0.50	0														
3	Mura (50% Grey)		Judged by Limit sample												
4	Corner Chip		Accept if (only allowed 1):- a) X ≤ 1.0mm b) Y ≤ 1.0mm c) Z ≤ 1/2T 												
	Edge Chip	- Touch sensor corner and edge chip that do not cause any damage to tracer and not visible to end-user after housing assembly. - Lens edge and corner chip that is not visible to end-user after housing assembly.	Accept if (only allowed 1):- a) X ≤ 1.0mm b) Y ≤ 1.0mm c) Z ≤ 1/2T Reject – if the sensor surface edge/corner chip damage circuit and visible from front view												
	Glass Crack		Reject – if any crack 												



5	Printing Ink Light Leakage		<p>Accept if:- Light leakage at marginal area width $\leq 0.15\text{mm}$</p> 
6	Surface Smudginess	<p>- For those that can be cleaned, $\leq 20\%$ of inspected quantity in one lot under > class 10K area; $\leq 10\%$ of inspected quantity in one lot \leq class 10K area. - For those that cannot be cleaned it is classified as foreign round shape defect.</p>	
7	FPC Defects on Contact Pad		<p>Accept if dent, pinhole:- a) $a \leq w/3$</p>  <p>Reject – if open circuit / cracking / oxidation / contamination</p>
	FPC Broken		<p>Reject if FPC broken / extruded</p> 
	FPC Warped		<p>Accept if FPC warped</p> 



11. Precaution

1. Handling Precautions

- a. The display panel is made of glass and polarizer. As glass is fragile. It tends to chip during handling especially on the edges. Please avoid dropping or jarring. Do not subject it to a mechanical shock of impact or by dropping it.
- b. If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance is in contact with your skin or clothes, wash it off using soap and water.
- c. Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary. Do not touch the display with bare hands. This will stain the display area and degrade the insulation between terminals. Scratch and dents may occur on polarizer too.
- d. The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully. Do not touch, push or rub the exposed polarizers with anything harder than a HB pencil lead (glass, tweezers, etc.). Do not put or attach anything on the display area to avoid leaving marks on it. Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizer. After products are tested at low temperature they must be warmed up in a container before coming in to contact with room temperature air.
- e. If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents.
 - Isopropyl alcohol.
 - Ethyl alcohol.
 - Do not scrub hard to avoid damaging the display surface.
- f. Solvents other than those above-mentioned may damage the polarizer. Especially, do not use the following.
 - Water.
 - Ketone.
 - Aromatic solvents.
 - Wipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or colour fading. Avoid contact with oil and fats.
- g. Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
- h. Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.
- i. Do not attempt to disassemble or process the LCD module.
- j. NC terminal should be open. Do not connect anything.
- k. If the logic circuit power is off, do not apply the input signals.
- l. Electro-Static Discharge Control. Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - Before removing LCM from its packing case or incorporating it into a set, be sure the module and your body have the same electric potential. Be sure to ground the body when handling the LCD modules.
 - Tools required for assembly, such as soldering irons, must be properly grounded. Make certain the AC power source for the soldering iron does not leak. When using an electric screwdriver to attach LCM, the screw driver should be of ground potentiality to minimize as much as possible any transmission of electromagnetic waves produced sparks coming from the commutator of the motor.



- To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions. To reduce the generation of static electricity be careful that the air in the work environment is not too dry. A relative humidity of 50%-60% is recommended. As far as possible make the electric potential of your work clothes and that of the work bench the ground potential.
- The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.
- m. Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.
 - Do not alter, modify or change the shape of the tab on the metal frame.
 - Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.
 - Do not damage or modify the pattern writing on the printed circuit board.
 - Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector.
 - Except for soldering the interface, do not make any alterations or modifications with a soldering iron.
 - Do not drop, bend or twist the LCM.

2. Storage Precautions

When storing the LCD modules, the following precaution are necessary.

- a. Store the LCD at a temperature from 10°C to 30°C and a relative humidity of 65% RH or less.
- b. Please store display in a dry place and shelter from direct sunlight.

3. Others

- a. Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature.
- b. If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.
- c. To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc. Exercise care to avoid holding the following sections when handling the modules.
 - Exposed area of the printed circuit board.
 - Terminal electrode sections.

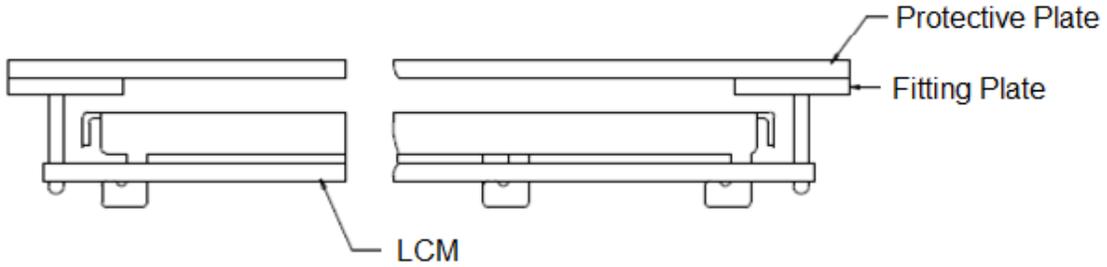
4. Using LCD Modules

a. Installing LCD Modules

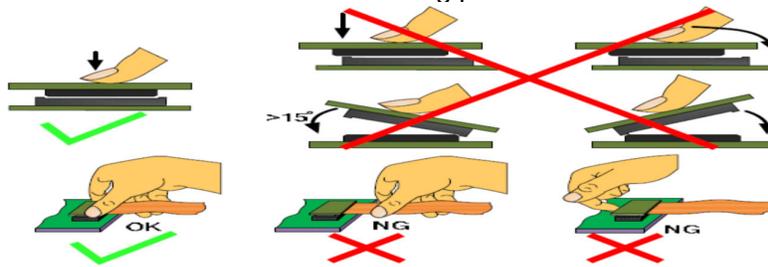
The hole in the printed circuit board is used to fix LCM as shown in the picture below.

Attend to the following items when installing the LCM.

- b. Cover the surface with a transparent protective plate to protect the polarizer and LC cell.



- c. When assembling the LCM into other equipment, the spacer to the bit between the LCM and the fitting plate should have enough height to avoid causing stress to the module surface, refer to the individual specifications for measurements. The measurement tolerance should be 0.1mm.
- d. Precaution for assemble the module with BTB connector:
Please note the position of the male and female connector position, don't assemble or assemble like the method which the following picture shows.



5. Precaution for soldering the LCM

	Manual soldering	Machine drag soldering	Machine press soldering
No RoHS Product	290°C ~350°C. Time: 3-5S.	330°C ~350°C. Speed: 4-8 mm/s.	300°C ~330°C. Time: 3-6S. Press: 0.8~1.2Mpa
RoHS Product	340°C ~370°C. Time: 3-5S.	350°C ~370°C. Time: 4-8 mm/s.	330°C ~360°C. Time: 3-6S. Press: 0.8~1.2Mpa

- a. If soldering flux is used, be sure to remove any remaining flux after finishing the soldering operation (This does not apply in the case of a non-halogen type of flux). It is recommended that you protect the LCD surface with a cover during soldering to prevent any damage due to flux spatters.
- b. When soldering the electroluminescent panel and PC board, the panel and board should not be detached more than three times. This maximum number is determined by the temperature and time conditions mentioned above, though there may be some variance depending on the temperature of the soldering iron.
- c. When removing the electroluminescent panel from the PC board, be sure the solder has completely melted, the soldered pad on the PC board could be damaged.

6. Precautions for Operation

- a. Viewing angle varies with the change of liquid crystal driving voltage (VLCD). Adjust VLCD to show the best contrast.
- b. It is recommended to drive LCD's within the specified voltage limit since over limit will cause shorter LCD life. An electrochemical reaction due to direct current causes LCD deterioration. Avoid the use of direct current drive.
- c. Response time will be extremely delayed at lower temperature compared to room operating temperature range and on the other hand, at higher temperature LCD-shows dark colour in



them. However those phenomena do not mean malfunction. The LCD will return to normal performance when ambient temperature revert to room condition.

- d. If the display area is pushed hard during operation, the display will become abnormal. However, it will return to normal if it is turned off and on.
- e. A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit.
- f. Apply logic voltage before applying analogue high voltage such as LCD driving voltage when powering on. Remove analogue high voltage before removing logic voltage when powering off the module. Input each signal after the positive/negative voltage becomes stable.
- g. Please keep the temperature within the specified range for use and storage. Polarization degradation, bubble generation or polarizer peel-off may occur with high temperature and high humidity.

7. Safety

- a. It is recommended to crush damaged or unnecessary LCDs into pieces and wash them off with solvents such as acetone and ethanol, which should later be burned.
- b. If any liquid leaks out of a damaged glass cell and comes in contact with the hands, wash off thoroughly with soap and water.

8. Limited Warranty

Unless otherwise agreed between Crystal Clear Technology and customer, Crystal Clear Technology will replace or repair any of its LCD and LCM which is found to be defective electrically and visually when inspected in accordance with Crystal Clear Technology acceptance standards, for a period of one year from date of shipment. Confirmation of such date shall be based on freight documents. The warranty liability of Crystal Clear Technology is limited to repair and/or replacement on the terms set forth above. Crystal Clear Technology will not responsible for any subsequent or consequential events.

9. Return LCM under Warranty

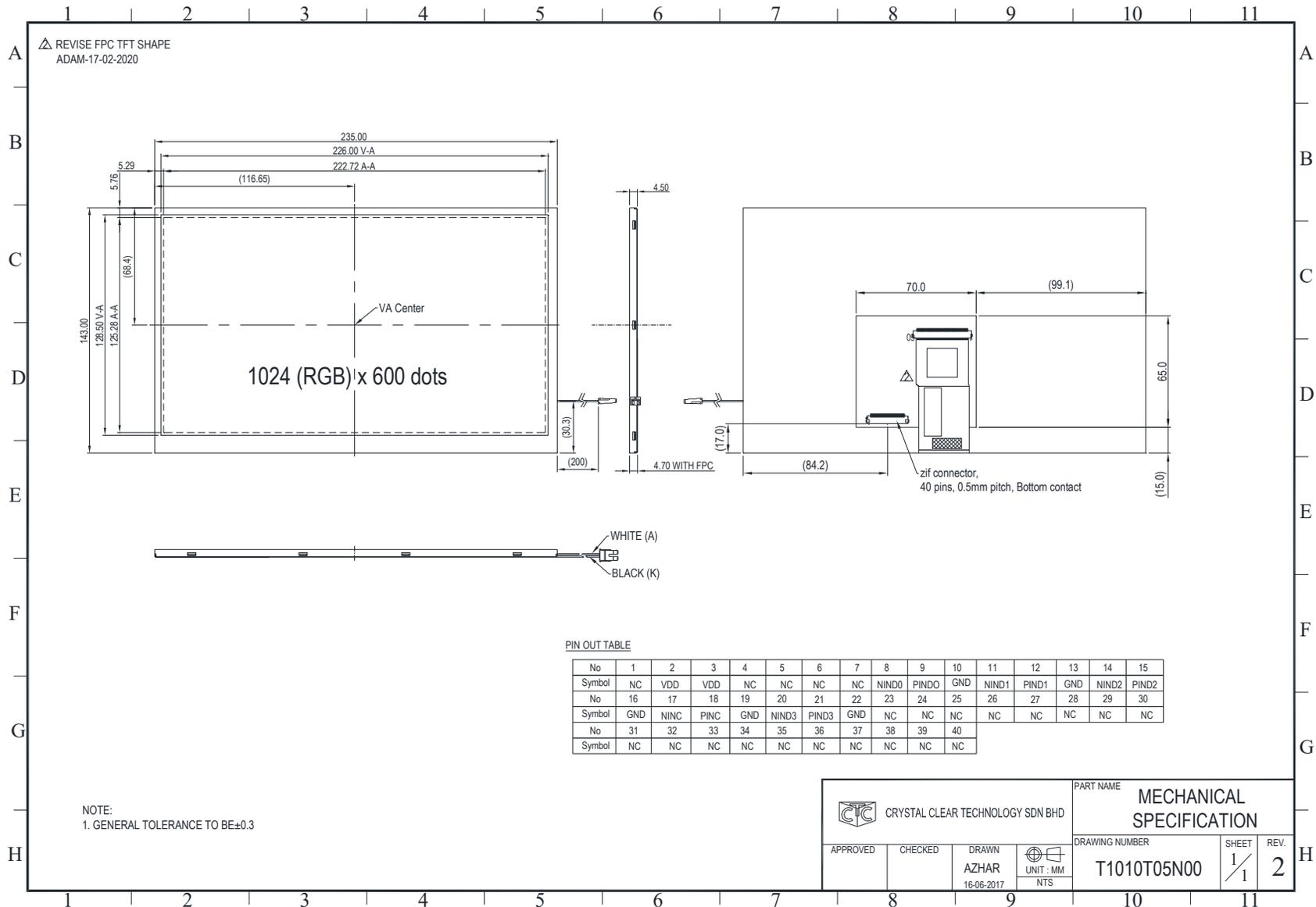
No warranty can be granted if the precautions stated above have been disregarded. The typical examples of violations are:

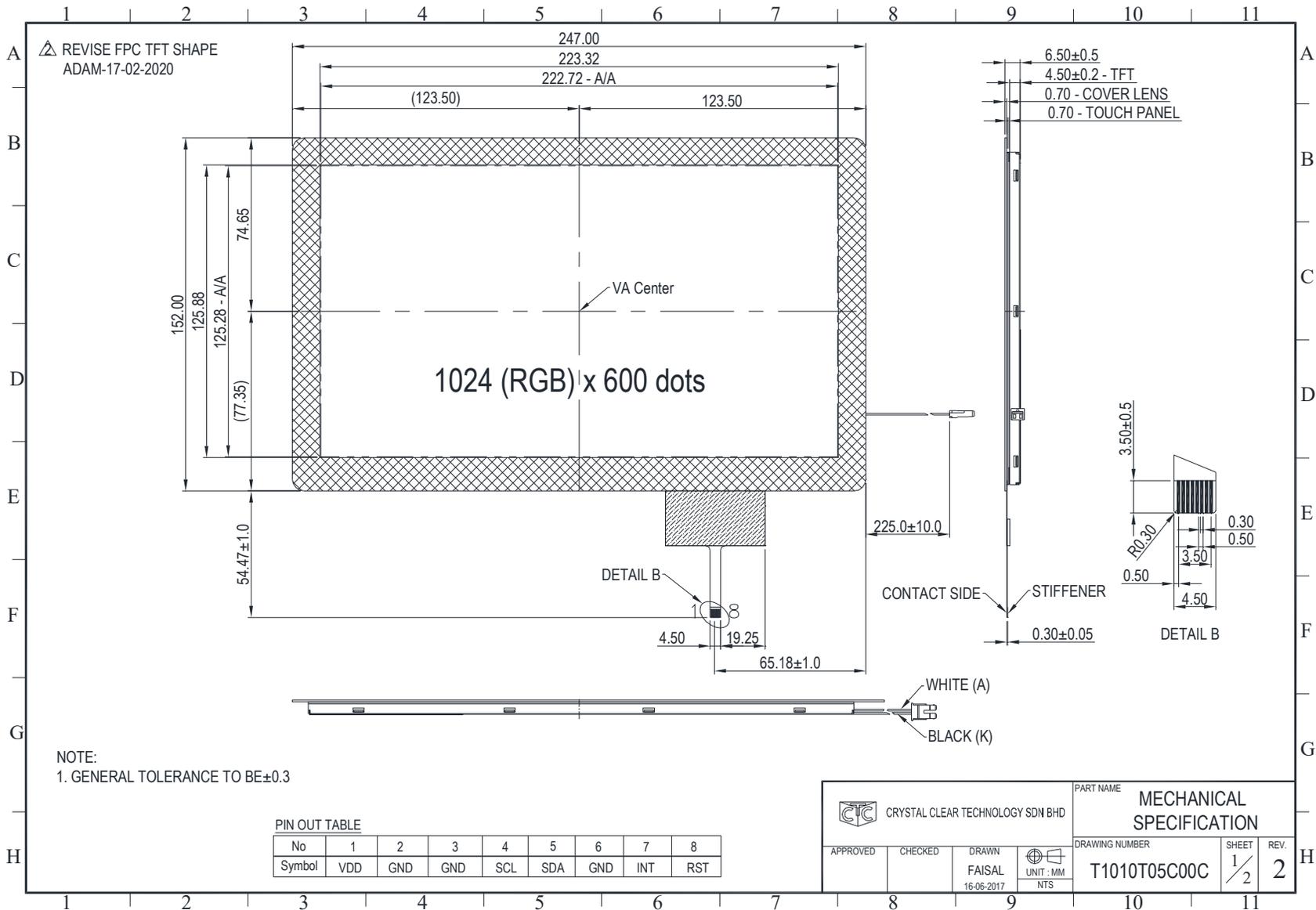
- Broken LCD glass.
- PCB eyelet's damaged or modified.
- PCB conductors damaged.
- Circuit modified in any way, including addition of components.
- PCB tampered with by grinding, engraving or painting varnish.
- Soldering to, or modifying the bezel in any manner.

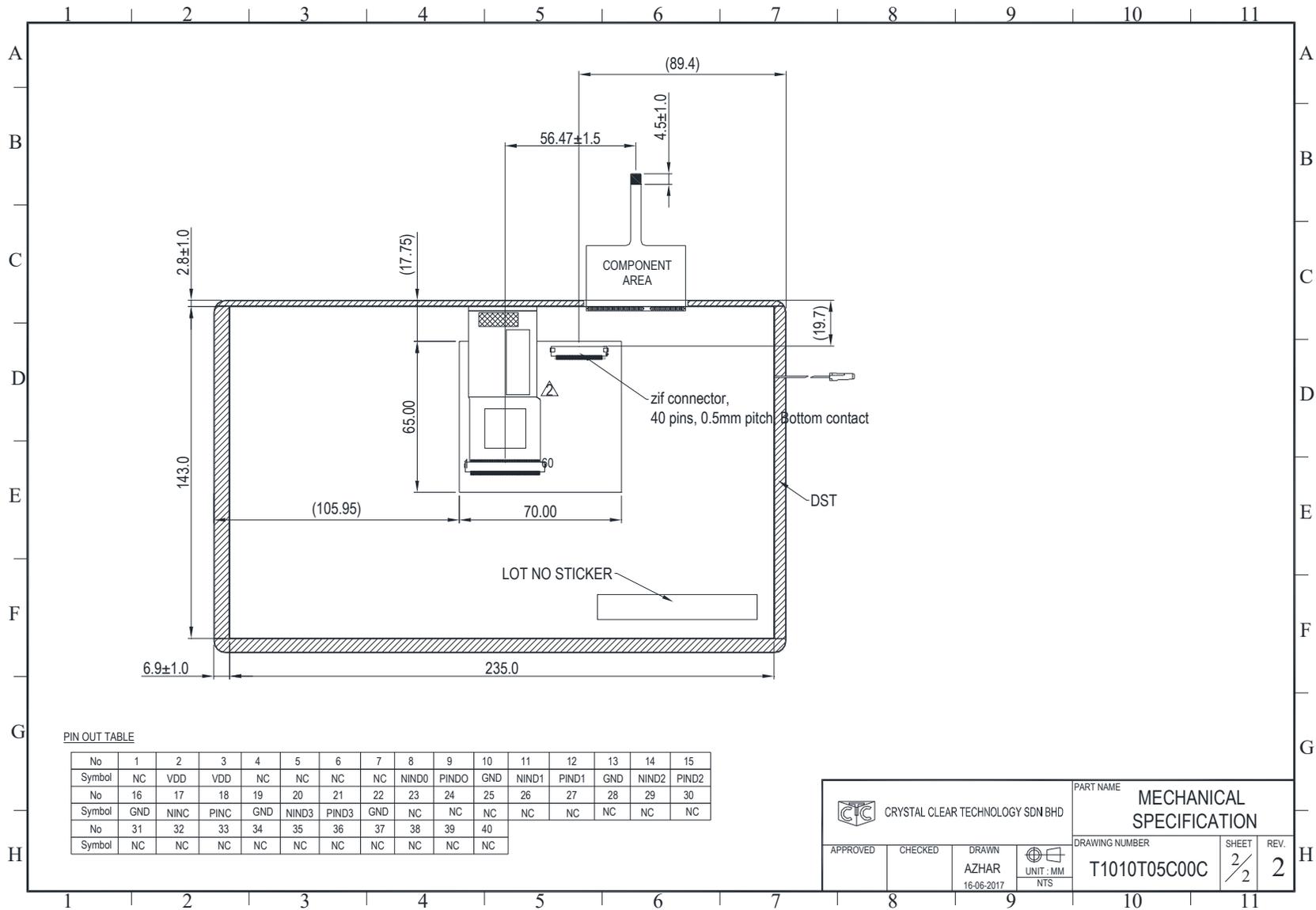
Module repairs will be invoiced to customer upon mutual agreement. Modules must be returned with sufficient description of failure or defects. Any connectors or cable installed by customer must be removed completely without damaging the PCB eyelet's, conductors and terminals.



12. Mechanical Specification



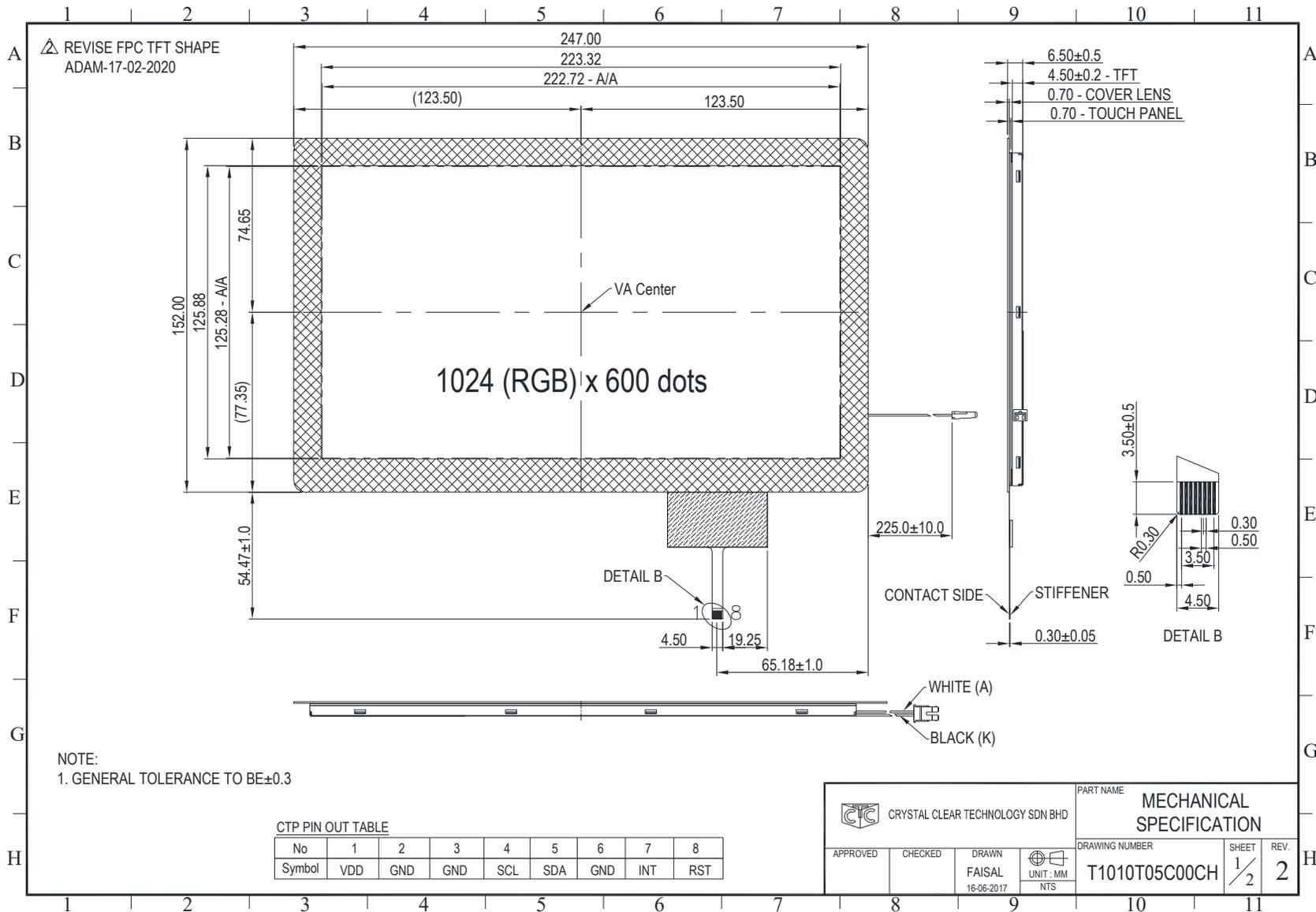


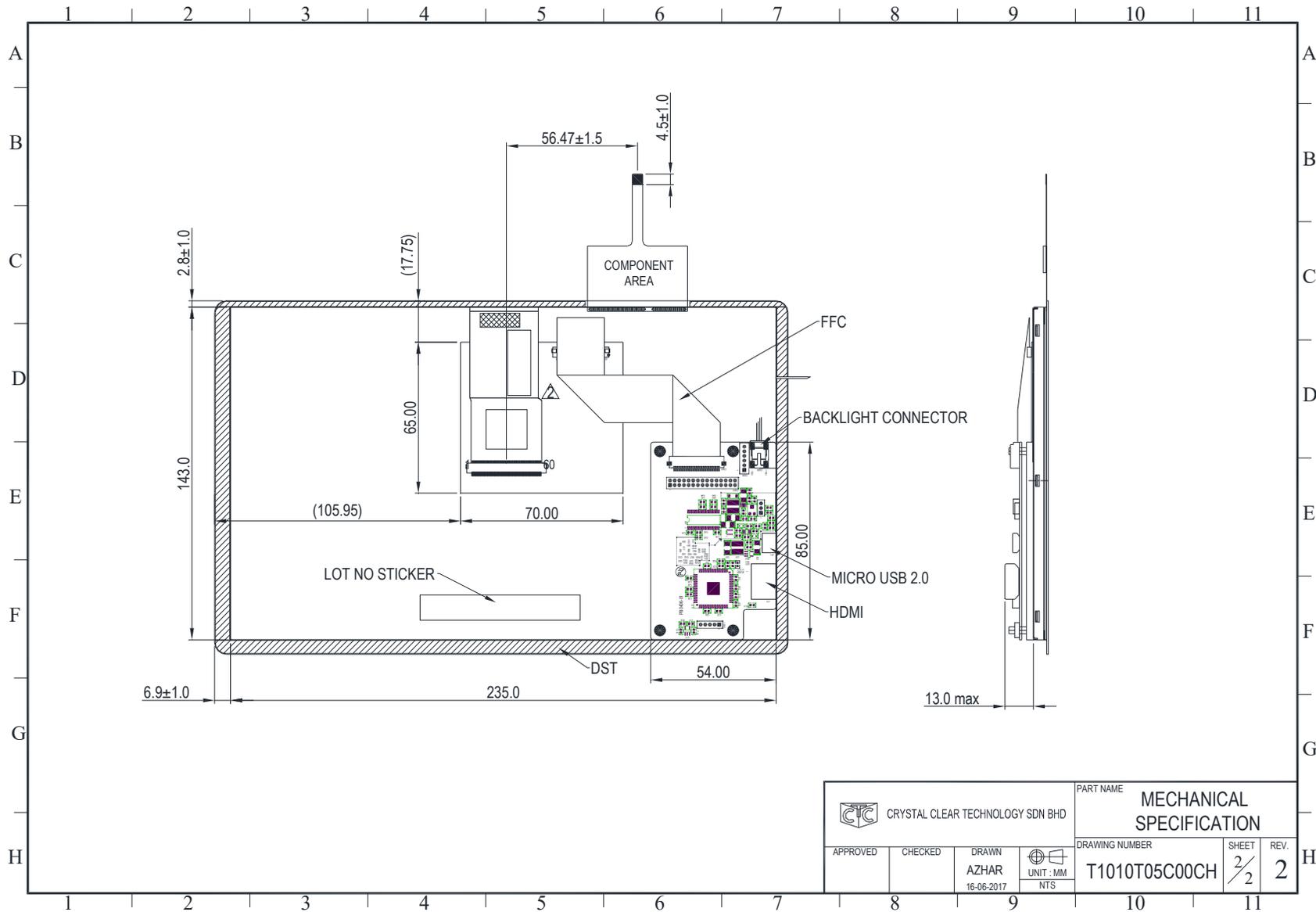


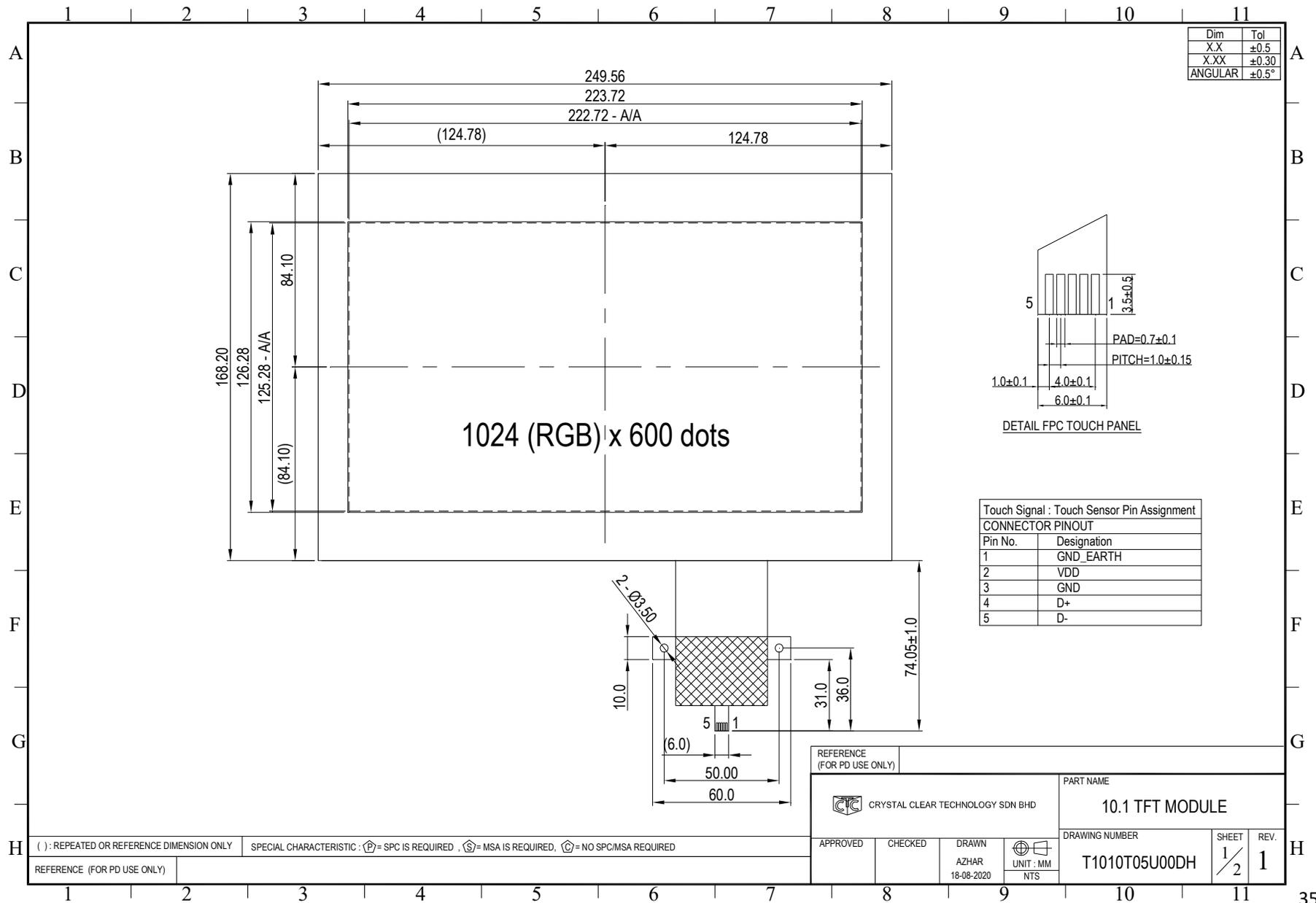
PIN OUT TABLE

No	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15
Symbol	NC	VDD	VDD	NC	NC	NC	NC	NIND0	PIND0	GND	NIND1	PIND1	GND	NIND2	PIND2
No	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30
Symbol	GND	NINC	PINC	GND	NIND3	PIND3	GND	NC	NC	NC	NC	NC	NC	NC	NC
No	31	32	33	34	35	36	37	38	39	40					
Symbol	NC	NC	NC	NC	NC	NC	NC	NC	NC	NC					

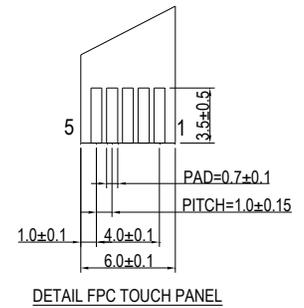
CRYSTAL CLEAR TECHNOLOGY SDN BHD				PART NAME MECHANICAL SPECIFICATION	
APPROVED	CHECKED	DRAWN AZHAR 16-06-2017	UNIT: MM NTS	DRAWING NUMBER T1010T05C00C	SHEET 2/2
					REV. 2







Dim	Tol
X.X	±0.5
X.XX	±0.30
ANGULAR	±0.5°



Touch Signal : Touch Sensor Pin Assignment	
CONNECTOR PINOUT	
Pin No.	Designation
1	GND_EARTH
2	VDD
3	GND
4	D+
5	D-

REFERENCE (FOR PD USE ONLY)				PART NAME	
CRYSTAL CLEAR TECHNOLOGY SDN BHD				10.1 TFT MODULE	
APPROVED	CHECKED	DRAWN	DRAWING NUMBER		SHEET
		AZHAR	T1010T05U00DH		1/2
		18-08-2020	UNIT : MM		REV.
		NTS			1

() : REPEATED OR REFERENCE DIMENSION ONLY SPECIAL CHARACTERISTIC : (P)= SPC IS REQUIRED, (M)= MSA IS REQUIRED, (C)= NO SPC/MSA REQUIRED

